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	Application Number	To be assigned	
INFORMATION DISCLOSURE	Filing Date	July 29, 2003 (herewith)	
STATEMENT BY APPLICANT	First Named Inventor	Jae-han CHA	
	Art Unit	To be assigned	
(use as many sheets as necessary)	Examiner Name	To be assigned	
Sheet 1 of 1	Attorney Docket Number	29925/39488	

U.S. PATENT DOCUMENTS							
Examiner Initials*	Cite No.1	Document Number  Number-Kind Code <sup>2</sup> (If known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear		
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FOREIGN PATENT DOCUMENTS								
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r.		Kinoshita et al., "Process Integration Technology for sub-30 ps ECL BiCMOS using Heavily
CL_		Boron Doped Epitaxial Contact (HYDEC)," Electron Devices Meeting, 1994. Technical Digest
Q_	1	Boron Doped Epitaxial Contact (HYDEC)," Electron Devices Meeting, 1994. Technical Digest, International, 11-14 Dec 1994 pp. 441-444.
<u>CL</u>	1	Boron Doped Epitaxial Contact (HYDEC)," Electron Devices Meeting, 1994. Technical Digest

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